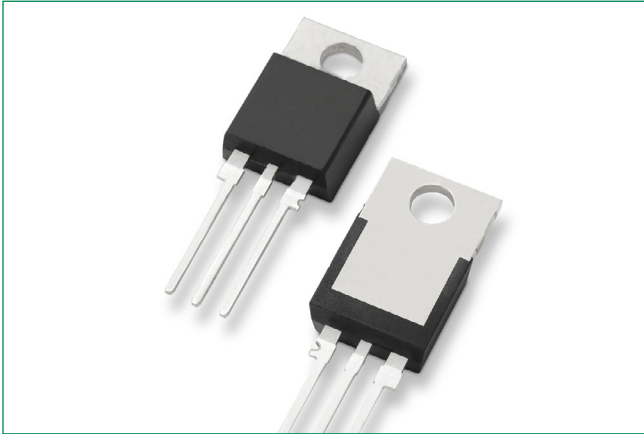




MCR69-2, MCR69-3

Silicon Controlled Rectifiers – 400V - 800V



Description

Designed for overvoltage protection in crowbar circuits.

Features & Benefits

- Glass-Passivated Junctions for Greater Parameter Stability and Reliability
- Center-Gate Geometry for Uniform Current Spreading Enabling High Discharge Current
- Small Rugged, Thermowatt Package Constructed for Low Thermal Resistance and Maximum Power Dissipation and Durability
- High Capacitor Discharge Current, 750 Amps
- Pb-Free Packages are Available

Additional Information



Resources

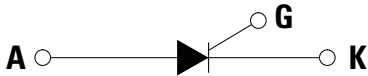


Accessories

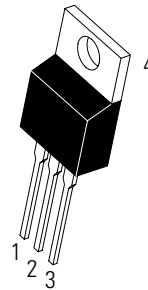


Samples

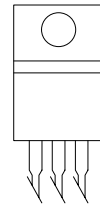
Functional Diagram



Pin Out



**TO-220AB
Case 221A
Style 3**



MCR69-2, MCR69-3

Silicon Controlled Rectifiers – 400V - 800V

Maximum Ratings ($T_J = 25^\circ\text{C}$ unless otherwise noted)

| Rating | Part Number | Symbol | Value | Unit |
|--|---------------------|---------------------|-------------|------------------------|
| Peak Repetitive Off-State Voltage (Note 1) ($T_J = -40$ to $+125^\circ\text{C}$, Gate Open) | MCR169-2 MCR69-3 | V_{DRM} | 50 | V |
| | | V_{RRM} | 100 | |
| Peak Discharge Current (Note 2) | | I_{TM} | 750 | A |
| On-State RMS Current (180° Conduction Angles; $T_C = 85^\circ\text{C}$) | | $I_{\text{T(RMS)}}$ | 25 | A |
| Average On-State Current (180° Conduction Angles; $T_C = 80^\circ\text{C}$) | | $I_{\text{T(AV)}}$ | 16 | A |
| Peak Non-Repetitive Surge Current (1/2 Cycle, Sine Wave, 60 Hz, $T_J = 125^\circ\text{C}$) | | I_{TSM} | 300 | A |
| Circuit Fusing Considerations ($t = 8.3$ ms) | | I^2t | 375 | A^2sec |
| Forward Peak Gate Current ($t \leq 1.0$ μs , $T_C = 85^\circ\text{C}$) | | I_{GM} | 2.0 | A |
| Forward Peak Gate Power ($t \leq 1.0\mu\text{s}$, $T_C = 85^\circ\text{C}$) | | P_{GM} | 20 | W |
| Operating Junction Temperature Range | | T_J | -40 to +125 | $^\circ\text{C}$ |
| Storage Temperature Range | | T_{stg} | -40 to +150 | $^\circ\text{C}$ |
| Mounting Torque | | – | 8.0 | in. lb. |

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

- VDRM and VRRM for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.
- Ratings apply for $t_w = 1$ ms. See Figure 1 for ITM capability for various duration of an exponentially decaying current waveform, t_w is defined as 5 time constants of an exponentially decaying current pulse.
- Test Conditions: $I_g = 150$ mA, $V_D = \text{Rated } V_{\text{DRM}}$, $I_{\text{TM}} = \text{Rated Value}$, $T_J = 125^\circ\text{C}$.

Thermal Characteristics

| Characteristic | Symbol | Value | Unit |
|--|------------------|-------|---------------------------|
| Thermal Resistance, Junction-to-Case | R_{eJC} | 1.5 | $^\circ\text{C}/\text{W}$ |
| Thermal Resistance, Junction-to-Ambient | R_{eJA} | 60 | |
| Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 10 seconds | T_L | 260 | $^\circ\text{C}$ |

Electrical Characteristics - OFF ($T_J = 25^\circ\text{C}$ unless otherwise noted)

| Characteristic | Symbol | Min | Typ | Max | Unit |
|---|---------------------------|-----|-----|-----|---------------|
| Peak Repetitive Forward or Reverse Blocking Current ($V_{\text{AK}} = V_{\text{DRM}} = V_{\text{RRM}}$; Gate Open) | $T_J = 25^\circ\text{C}$ | - | - | 10 | μA |
| | $T_J = 125^\circ\text{C}$ | - | - | 2.0 | mA |

Electrical Characteristics - ON

| Characteristic | Symbol | Min | Typ | Max | Unit |
|--|--|-----|------|-----|---------------|
| Peak Forward On-State Voltage | (Note 4) ($I_{\text{TM}} = 50$ A) | – | – | 1.8 | V |
| | ($I_{\text{TM}} = 750$ A, $t_w = 1$ ms) (Note 5) | – | 6.0 | – | |
| Gate Trigger Current (Continuous dc) ($V_D = 12$ V, $R_L = 100$ Ω) | I_{GT} | 2.0 | 7.0 | 30 | mA |
| Gate Trigger Voltage (Continuous dc) ($V_D = 12$ Vdc, $R_L = 100$ Ω) | V_{GT} | – | 0.65 | 1.5 | V |
| Gate Non-Trigger Voltage (Continuous dc) ($V_D = 12$ Vdc, $R_L = 100$ Ω , $T_J = 125^\circ\text{C}$) | V_{GD} | 0.2 | 0.40 | – | V |
| Holding Current ($V_D = 12$ Vdc, Initiating Current = 200 mA, Gate Open) | I_{H} | 3.0 | 15 | 50 | mA |
| Latch Current ($V_D = 12$ Vdc, $I_G = 150$ mA) | I_{L} | – | – | 60 | mA |
| Gate Controlled Turn-On Time (Note 6) ($V_D = \text{Rated } V_{\text{DRM}}$, $I_G = 150$ mA) ($I_{\text{TM}} = 50$ A Peak) | t_{gt} | – | 1.0 | – | μs |

MCR69-2, MCR69-3

Silicon Controlled Rectifiers – 400V - 800V

Dynamic Characteristics

| Characteristic | Symbol | Min | Typ | Max | Unit |
|---|--------|-----|-----|-----|------------------|
| Critical Rate-of-Rise of Off-State Voltage ($V_D = \text{Rated } V_{DRM}$, Exponential Waveform, Gate Open, $T_J = 125^\circ\text{C}$) | dv/dt | 10 | - | - | V/ μs |
| Critical Rate of Rise of On-State Current $I_G = 150 \text{ mA}$, $T_J = 125^\circ\text{C}$ | di/dt | - | - | 100 | A/ μs |

- 4. Pulse duration $\leq 300 \mu\text{s}$, duty cycle $\leq 2\%$.
- 5. Ratings apply for $t_w = 1 \text{ ms}$. See Figure 1 for I_{TM} capability for various durations of an exponentially decaying current waveform. t_w is defined as 5 time constants of an exponentially decaying current pulse.
- 6. The gate controlled turn-on time in a crowbar circuit will be influenced by the circuit inductance.

Voltage Current Characteristic of SCR

| Symbol | Parameter |
|-----------|---|
| V_{DRM} | Peak Repetitive Forward Off State Voltage |
| I_{DRM} | Peak Forward Blocking Current |
| V_{RRM} | Peak Repetitive Reverse Off State Voltage |
| I_{RRM} | Peak Reverse Blocking Current |
| V_{TM} | Maximum On State Voltage |
| I_H | Holding Current |

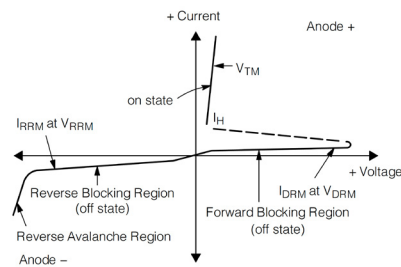


Figure 1. Typical RMS Current Derating

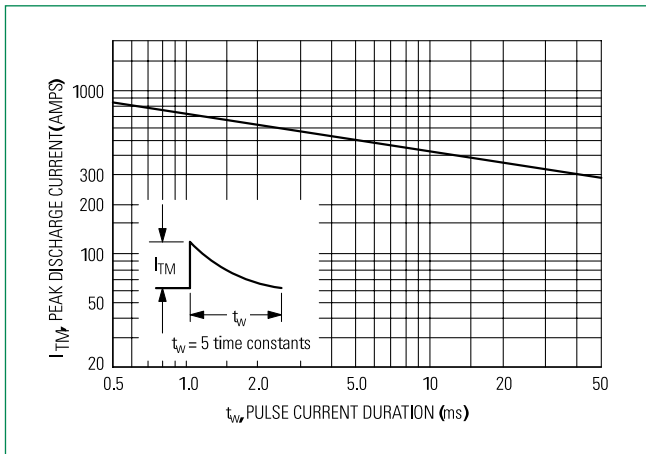


Figure 2. Peak Capacitor Discharge Current Derating

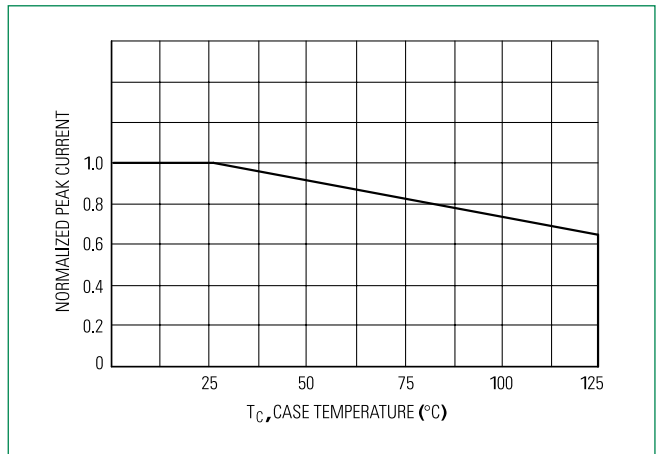


Figure 3. Current Derating

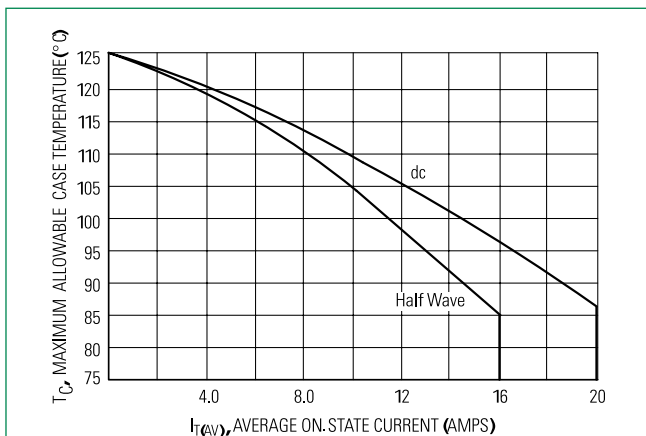
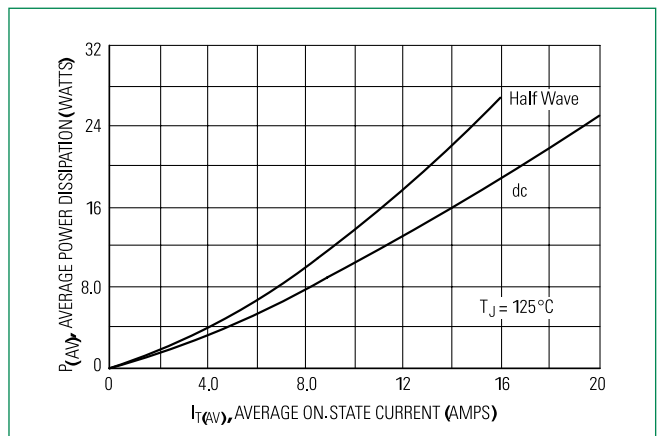


Figure 4. Maximum Power Dissipation



MCR69-2, MCR69-3

Silicon Controlled Rectifiers – 400V - 800V

Figure 5.
Thermal Response

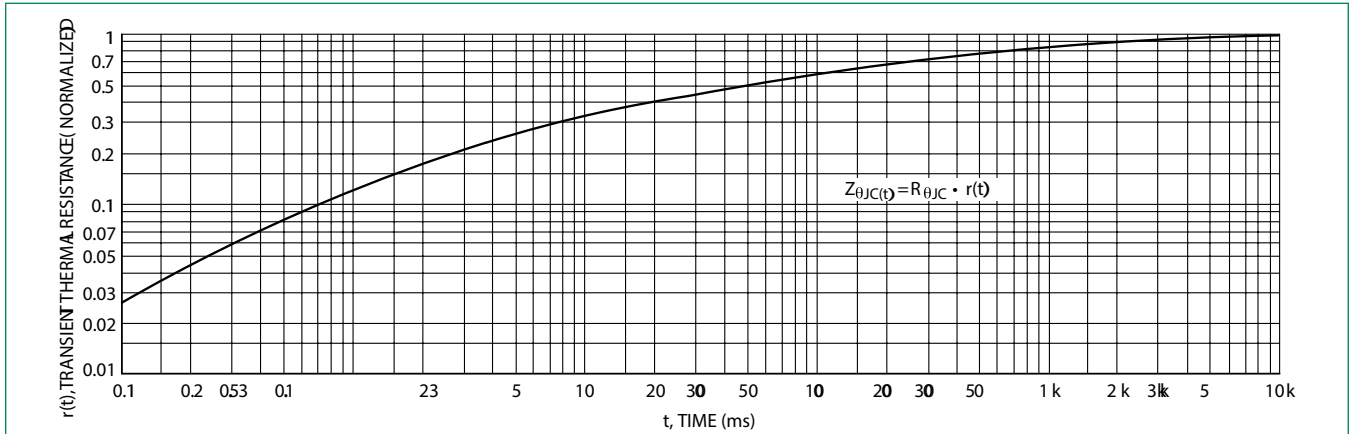


Figure 6.
Gate Trigger Current

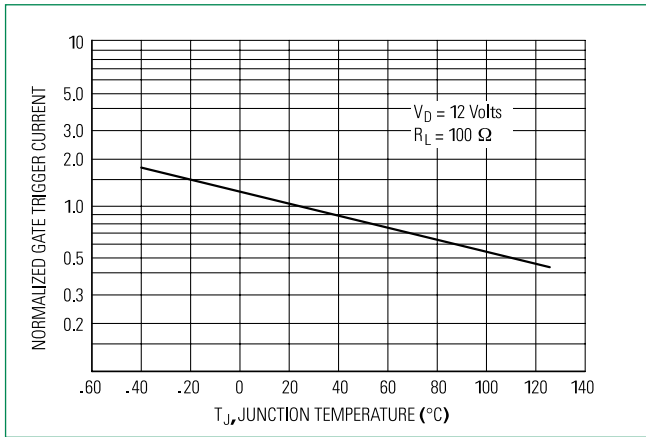


Figure 7.
Gate Trigger Voltage

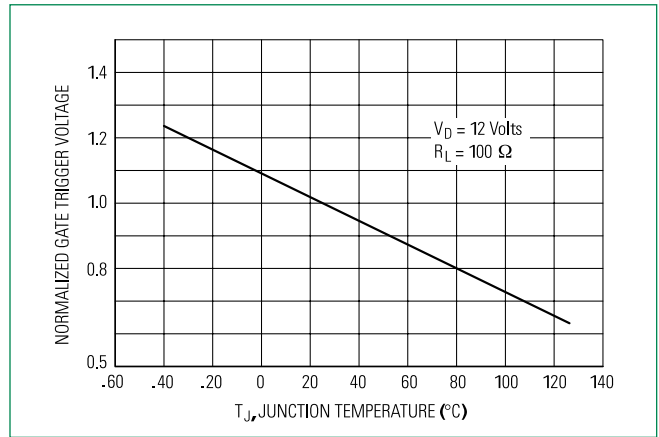
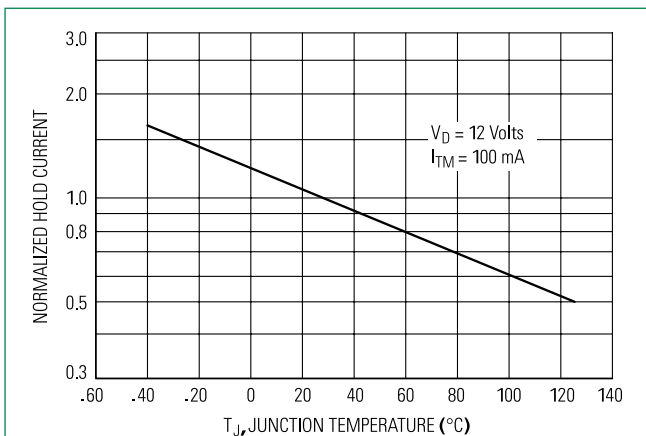


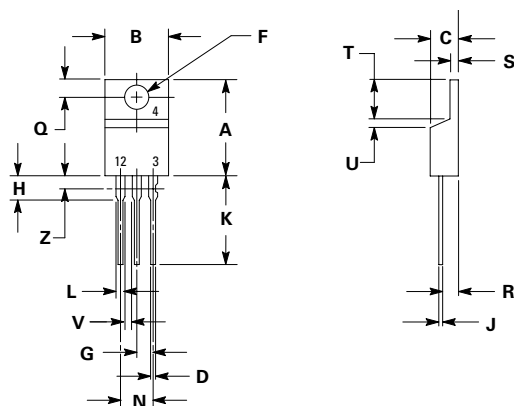
Figure 8.
Holding Current



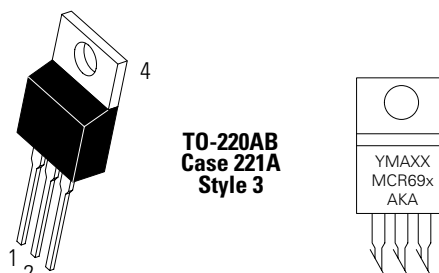
MCR69-2, MCR69-3

Silicon Controlled Rectifiers – 400V - 800V

Dimensions



Part Marking System



**TO-220AB
Case 221A
Style 3**

MCR69 = Device Code
 Y = Year
 M = Month
 A = Assembly Site
 AKA = Diode Polarity
 G = Pb-Free Package

| Dim | Inches | | Millimeters | |
|-----|--------|-------|-------------|-------|
| | Min | Max | Min | Max |
| A | 0.590 | 0.620 | 14.99 | 15.75 |
| B | 0.380 | 0.420 | 9.65 | 10.67 |
| C | 0.178 | 0.188 | 4.52 | 4.78 |
| D | 0.025 | 0.035 | 0.64 | 0.89 |
| F | 0.142 | 0.147 | 3.61 | 3.73 |
| G | 0.095 | 0.105 | 2.41 | 2.67 |
| H | 0.110 | 0.130 | 2.79 | 3.30 |
| J | 0.018 | 0.024 | 0.46 | 0.61 |
| K | 0.540 | 0.575 | 13.72 | 14.61 |
| L | 0.060 | 0.075 | 1.52 | 1.91 |
| N | 0.195 | 0.205 | 4.95 | 5.21 |
| Q | 0.105 | 0.115 | 2.67 | 2.92 |
| R | 0.085 | 0.095 | 2.16 | 2.41 |
| S | 0.045 | 0.060 | 1.14 | 1.52 |
| T | 0.235 | 0.255 | 5.97 | 6.47 |
| U | 0.000 | 0.050 | 0.00 | 1.27 |
| V | 0.045 | --- | 1.15 | --- |
| Z | --- | 0.080 | --- | 2.04 |

| Pin Assignment | |
|----------------|---------|
| 1 | Cathode |
| 2 | Anode |
| 3 | Gate |
| 4 | Anode |

Ordering Information

| Device | Package | Shipping |
|----------|-------------------------|------------|
| MCR69-2 | TO-220AB | 1000 / Box |
| MCR69-2G | TO-220AB (Lead-Free) | |
| MCR69-3 | TO-220AB | |
| MCR69-3G | TO-220AB (Lead-Free) | |

1. Dimensioning and tolerancing per ansi y14.5m, 1982.
 2. Controlling dimension: inch.
 3. Dimension z defines a zone where all body and lead irregularities are allowed.

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